	Туре	Hits	Search Text	DBs	Time Stamp
52	BRS		(electrodes and semiconductor adj (chip chips) and resin and metal).clm.	US-PGPUB	2005/12/09 17:35
53	BRS	2	(electrodes and semiconductor adj (chip chips) and resin and metal adj (protective protection protect protecting)).clm.		2005/12/09 17:36
54	BRS	4	(electrodes and semiconductor adj (chip chips) and resin and metal with (protective protection protect protecting)).clm.	US-PGPUB	2005/12/09 17:36
55	BRS		(electrodes with semiconductor adj (chip chips) with resin and metal).clm.		2005/12/09 17:36
56	BRS		(electrodes with semiconductor adj (chip chips) with resin and metal with resin).clm.	US-PGPUB	2005/12/09 17:37
57	BRS		(electrodes with semiconductor adj (chip chips) with resin and metal and resin with (insulating insulation)).clm.	US-PGPUB	2005/12/09 17:38
58	BRS)	(electrodes with semiconductor adj (chip chips) with resin and metal and resin near3 (insulating insulation)).clm.	IUS - PGPUR	2005/12/09 17:38
59	BRS		semiconductor adj chip and electrodes and resin near2	14' D() • . 1 D() •	2006/01/27 17:05
60	BRS	444	semiconductor adj chip and electrodes and resin near2 (insulation insulating insulated insulator) same metal	14'D() • . 1 D() •	2006/01/27 17:01
61	BRS	294	semiconductor adj chip same electrodes and resin near2 (insulation insulating insulated insulator) same metal	H'D() • . D() •	2006/01/27 17:22

	Туре	Hits	Search Text	DBs	Time Stamp
62	BRS	151	(insulation insulating insulated insulator) and metal with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/01/27 17:05
63	BRS	17	(insulation insulating insulated insulator) same metal with (protect protective protection	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/01/27 17:05
64	BRS	11	"5694300" "5731661" "5757126" "5771562"	$\Pi \subseteq D \Delta \cap \cdot$	2006/01/27 17:12
65	BRS		semiconductor adj chip same electrodes and resin near2 (insulation insulating insulated insulator) with metal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/01/27 17:22
66	BRS	209	electrodes and resin near2 (insulation insulating insulated insulator) with metal and	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/01/27 17:23
67	BRS	18	electrodes and resin near2 (insulation insulating insulated insulator) with metal and	H:P() • . P() • .	2006/01/27 17:23

	Hits	Search Text	DBs	Time Stamp
1		(electrodes and semiconductor adj (chip chips) and resin and metal).clm.	US-PGPUB	2006/01/30 16:49
2	2	(electrodes and semiconductor adj (chip chips) and resin and metal adj (protective protection protect protecting)).clm.	1114 - D(2D11R	2006/01/30 16:49
3	38	(electrodes with semiconductor adj (chip chips) with resin and metal).clm.	NIS - PGPHR	2006/01/30 16:49
4	25	(electrodes with semiconductor adj (chip chips) with resin and metal with resin).clm.	US-PGPUB	2006/01/30 16:49
5	11	(electrodes with semiconductor adj (chip chips) with resin and metal and resin with (insulating insulation)).clm.	US-PGPUB	2006/01/30 16:50
6	10	(electrodes with semiconductor adj (chip chips) with resin and metal and resin near3 (insulating insulation)).clm.	US-PGPUB	2006/01/30 16:50